

STRUCTURE Silicon Monolithic Integrated Circuit

NAME OF PRODUCT DC-AC Inverter Control IC

TYPE BD9244AFV

FUNCTION

• 36V High voltage process

- 1ch control with Full-Bridge
- Lamp current and voltage sense feed back control
- Sequencing easily achieved with Soft Start Control
- Short circuit protection with Timer Latch
- Under Voltage Lock Out and Over Voltage Protection
- Mode-selectable the operating or stand-by mode by stand-by pin
- BURST mode controlled by PWM and DC input

## OAbsolute Maximum Ratings ( $T = 2.5 ^{\circ}C$ )

Parameter	Symbol	Limits	Unit
Supply Voltage	VCC	36	٧
BST PIN	BST	40	٧
SW PIN	SW	36	٧
BST-SW voltage difference	BST-SW	15	٧
Operating Temperature Range	Topr	<b>-40∼+85</b>	°C
Storage Temperature Range	Tstg	-55 <b>~</b> +150	°C
Maximum Junction Temperature	Tjmax	+150	°C
Power Dissipation	Pd	1024*	mW

<sup>\*</sup>Pd derate at 5.6mW/°C for temperature above Ta = 25°C (When mounted on a PCB 70.0mm × 70.0mm × 1.6mm)

# OOperating condition

Parameter	Symbol	Limits	Unit
Supply voltage	VCC	9.0~30.0	٧
BST voltage	BST	5. 0 <b>~</b> 37. 5	٧
BST-SW voltage difference	BST-SW	5. 0 <b>~</b> 14. 0	٧
oscillation frequency	FOUT	30~110	kHz
BCT oscillation frequency	fBCT	0.05~1.00	kHz



OElectric Characteristics (Ta=25°C, VCC=24V, STB=3.0V)

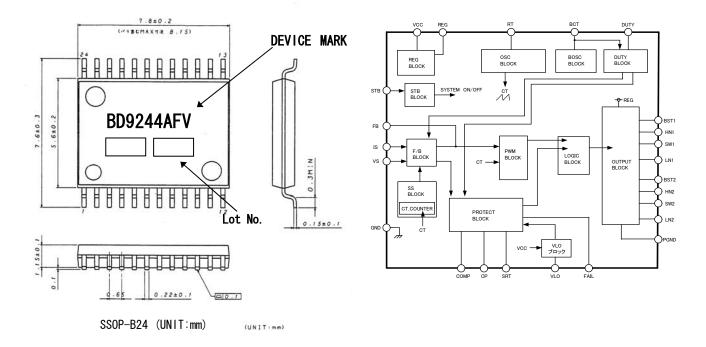
Parameter	Parameter Symbol		Limits			Conditions
i di allo toi	Oyinbo i	MIN.	TYP.	MAX.	Unit	33.14.13.13
((WHOLE DEVICE))						T-
Operating current	Icc1	_	2. 2	5. 0	mA	FOUT=60kHz, FB=SW=GND, BST=0PEN
Stand-by current	Icc2	_	0	10	μΑ	
((STAND BY CONTROL))	ı	1	1	1		1
Stand-by voltage H	VstH	2. 0	_	VCC	٧	System ON
Stand-by voltage L	VstL	-0. 3	_	1.0	٧	System OFF
((VCC UVLO BLOCK))		1	1	1	-	1
Operating voltage (VCC)	V_VCCUVP	6. 17	6. 50	6. 83	٧	
Hesteresis width (VCC UVLO)	∠V_VCCUVP	0. 37	0. 50	0. 63	٧	
Operating voltage (UVLO)	V_UVP	1. 80	1. 85	1. 90	٧	
Hesteresis width(UVLO)	⊿V_UVP	0. 15	0. 20	0. 25	٧	
Operating voltage (OVP)	V_0VP	3. 10	3. 20	3. 30	٧	
Hesteresis width(OVP)	⊿V_0VP	0. 15	0. 20	0. 25	٧	
((REG BLOCK))				_		1
REG output voltage	VREG	7. 35	7. 50	7. 65	٧	VCC>8. 5V
REG source current	IREG	20	-	_	mA	
((OSC BLOCK)						
RT Output Voltage	VRT	1. 05	1. 50	1. 95	٧	
SRT ON Resistor value	RSRT	_	100	200	Ω	
((SOFT START BLOCK))	I	ı	ı			
Soft start time	TSS	2. 5	5. 0	10.0	ms	FOUT=60kHz
//B060 BL00K))						
((BOSC BLOCK))	VBCTH	2. 16	2. 25	2. 34	٧	FDCT-0 2kHz
BOSC Max voltage	VBCTL	0. 6	0.7	0.8	V	fBCT=0. 3kHz
BOSC Min voltage BOSC frequency	FBCT	291	300	309	Hz	fBCT=0. 3kHz BCT=10000pF
((FEED BACK BLOCK))	rboi	291	300	309	112	рот-тоооорг
IS threshold voltage	VIS1	1. 225	1. 250	1. 275	٧	
	VVS	1. 215	1. 250	1. 285	V	
VS threshold voltage IS source current 1	IIS1	-	-	0. 9	μA	DUTY=2. 45V
IS source current 2	1182	40	50	60	μA	DUTY=0V IS=1.0V
VS source current	IVS	-	_	0. 9		D011-0V 13-1.0V
IS COMP detect voltage	VISCOMP	0. 606	0. 625		μ A V	
((OUTPUT BLOCK))	VISCOMP	0. 000	0. 020	0. 644	v	
	Poink! N	1.5	2	6	0	
LN output sink resistance	RsinkLN Rsourcel N	1.5	3	20	Ω	
LN output source resistance HN output sink resistance	RsourceLN RsinkHN	1.5	3	6	Ω	VBST-VSW=7. 0V
HN output sink resistance HN output source resistance		5	10	20		
MAX DUTY	RsourceHN MAX DUTY	46.0	48. 5	49. 5	Ω %	VBST-VSW=7. 0V FOUT=60kHz
OFF period	TOFF	100	200	49. 5		I OUT = OUNITE
Drive output frequency	FOUT	57. 9	60	62. 1	ns kHz	RT=100k Ω
((TIMER LATCH BLOCK)	ji 001	J1. 3	1 00	VZ. I	KIIZ	N  = 100N 32
CP timer latch detect voltage	VCP	1. 9	2. 0	2. 1	V	
CP timer latch charge current	ICP	0. 85	1.0	1. 15	μ A	
				1		
FAIL ON Resistor value	RFAIL		125	250	Ω	1
((COMP BLOCK))	VCOMP	3. 88	4.0	A 10	V	
COMP over voltage detect voltage	/VCOMP		4. 0	4. 12		
Hysteresis width (COMP)	ZIVCOMP	0. 15	0. 20	0. 25	٧	

(This product is not designed to be radiation-resistant.)



### OPackage Dimensions

# OBlock Diagram



# **OPin Description**

PIN No.	PIN NAME	FUNCTION	PIN No.	PIN NAME	FUNCTION
1	PGND	Power Ground for FET drivers	13	FAIL	Error Indication signal output (Normal : L, Error : OPEN)
2	LN2	NMOS FET driver (Ch. 2)	14	CP	External capacitor between CP and GND for timer latch
3	BST2	Boot-strap input for HN2 output	15	FB	Error amplifier output
4	HN2	NMOS FET driver (Ch. 2)	16	IS	Error amplifier input 2
5	SW2	Lower rail voltage for HN2 output	17	VS	Error amplifier input 1
6	VCC	Power supply input with UVLO Protection	18	COMP	Input of over voltage detector
7	STB	Stand-by switch	19	VL0	External Under Voltage Lock Out and Over Voltage Protection
8	SRT	External resister from SRT to RT for adjusting the start-up Triangle oscilator	20	SW1	Lower rail voltage for HN1 output
9	RT	External resistor between RT and GND for adjustment frequency of saw tooth wave	21	HN1	NMOS FET driver (Ch. 1)
10	GND	Ground	22	BST1	Boot-strap input for HN1 output
11	BCT	External capacitor between BCT and GND for adjusting the BURST triangle oscillator	23	REG	regulator output
12	DUTY	Control Burst-dimming by PWM signal or DC	24	LN1	NMOS FET driver (Ch. 1)



#### ONOTE FOR USE

- 1. When designing the external circuit, including adequate margins for variation between external devices and IC. Use adequate margins for steady state and transient characteristics.
- 2. The circuit functionality is guaranteed within of ambient temperature operation range as long as it is within recommended operating range. The standard electrical characteristic values cannot be guaranteed at other voltages in the operating ranges, however the variation will be small.
- 3. Mounting failures, such as misdirection or miscounts, may harm the device.
- 4. A strong electromagnetic field may cause the IC to malfunction.
- 5. The GND pin should be the location within  $\pm 0.3V$  compared with the PGND pin.
- 6. If the voltage between VCC and I/O pins or GND and I/O pins is in opposite from the normal potential difference, unusual current flow into pins may occur which can destroy the IC. To avoid such occurrence it is recommended to place protection diodes for prevention against backward current flow.
- 7. BD9244AFV incorporate a built-in thermal shutdown circuit (TSD circuit). The thermal shutdown circuit (TSD circuit) is designed only to shut the IC off to prevent runaway thermal operation. It is not designed to protect the IC or guarantee its operation of the thermal shutdown circuit is assumed.
- 8. Absolute maximum ratings are those values that, if exceeded, may cause the life of a device to become significantly shortened.

  Moreover, the exact failure mode caused by short or open is not defined. Physical countermeasures, such as a fuse, need to be considered when using a device beyond its maximum ratings.
- 9. About the external FET, the parasitic Capacitor may cause the gate voltage to change, when the drain voltage is switching.

  Make sure to leave adequate margin for this IC variation.
- 1 O. By STB voltage, BD9244AFV are changed to 2 states. Therefore, do not input STB pin voltage between one state and the other state  $(1.0 \sim 2.0 \text{V})$ .
- 1 1. The pin connected a connector need to connect to the resistor for electrical surge destruction.
- 1 2. This IC is a monolithic IC which (as shown is Fig. 4) has  $P^*$  substrate and between the various pins. A P-N junction is formed from this P layer of each pin. For example, the relation between each potential is as follows,
  - O (When GND > PinB and GND > PinA, the P-N junction operates as a parasitic diode.)
  - O (When PinB > GND > PinA, the P-N junction operates as a parasitic transistor.)

Parasitic diodes can occur inevitably in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits as well as operation faults and physical damage. Accordingly you must not use methods by which parasitic diodes operate, such as applying a voltage that is lower than the GND (P substrate) voltage to an input pin

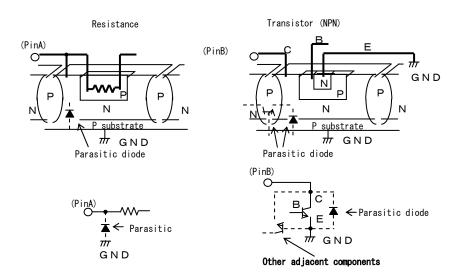


Fig. 4. Simplified structure of a Bipolar IC

### Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.



Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact us.

# ROHM Customer Support System

http://www.rohm.com/contact/